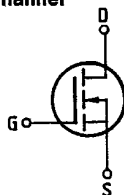


## SIEMENS AKTIENGESELLSCHAFT

## Main ratings

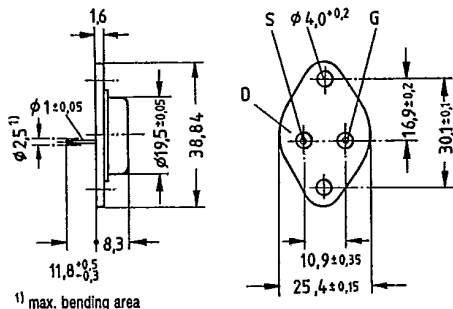
Drain-source voltage	$V_{DS}$	= 1000 V
Continuous drain current	$I_D$	= 2,3 A
Drain-source on-resistance	$R_{DS(on)}$	= 6 $\Omega$

## N-Channel



**Description** SIPMOS, N-channel, enhancement mode  
**Case** Metal case 3A2 in accordance with DIN 41872,  
 or TO 204 AA (TO 3) in accordance with JEDEC.  
 Approx. weight 12 g

Type	Ordering code
BUZ 53 C	C67078-A1009-A5



Dimensions in mm

## Maximum ratings

Description	Symbols	Ratings	Units	Conditions
Drain-source voltage	$V_{DS}$	1000	V	
Drain-gate voltage	$V_{DGR}$	1000	V	$R_{GS} = 20 \text{ k}\Omega$
Continuous drain current	$I_D$	2,3	A	$T_C = 30 \text{ }^\circ\text{C}$
Pulsed drain current	$I_{D,puls}$	9,0	A	$T_C = 25 \text{ }^\circ\text{C}$
Gate-source voltage	$V_{GS}$	$\pm 20$	V	
Max. power dissipation	$P_D$	78	W	$T_C = 25 \text{ }^\circ\text{C}$
Operating and storage temperature range	$T_J$ $T_{stg}$	-55 ... +150	$^\circ\text{C}$	
DIN humidity category	C		-	DIN 40040
IEC climatic category		55/150/56		DIN IEC 68-1

## Thermal resistance

Chip - case	$R_{th JC}$	$\leq 1,6$	K/W
Chip - ambient	$R_{th JA}$	$\leq 35$	K/W

## Electrical characteristics

(at  $T_J = 25^\circ\text{C}$  unless otherwise specified)

Description	Symbol	Characteristics			Unit	Conditions
		min.	typ.	max.		

### Static ratings

Drain-source breakdown voltage	$V_{(BR) DSS}$	1000	—	—	V	$V_{GS} = 0V$ $I_D = 0,25mA$
Gate threshold voltage	$V_{GS(th)}$	2,1	3,0	4,0		$V_{DS} = V_{GS}$ $I_D = 1mA$
Zero gate voltage drain current	$I_{DSS}$	—	20 100	250 1000	$\mu A$	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ $V_{DS} = 1000V$ $V_{GS} = 0V$
Gate-source leakage current	$I_{GSS}$	—	10	100		nA
Drain-source on-resistance	$R_{DS(on)}$	—	5,0	6,0	$\Omega$	$V_{GS} = 10V$ $I_D = 1,5A$

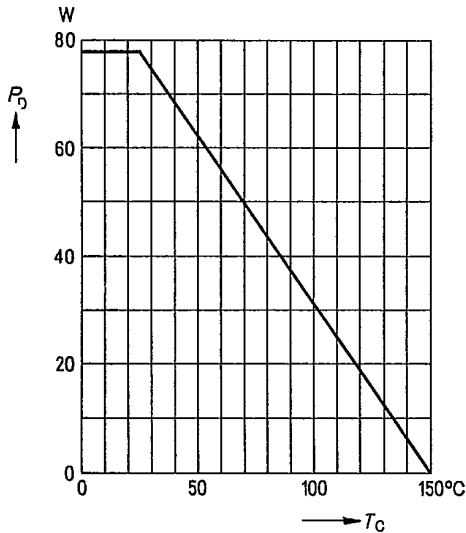
### Dynamic ratings

Forward transconductance	$g_{fs}$	0,7	1,5	—	S	$V_{DS} = 25V$ $I_D = 1,5A$
Input capacitance	$C_{iss}$	—	1,6	2,1		nF
Output capacitance	$C_{oss}$	—	70	120	pF	
Reverse transfer capacitance	$C_{rss}$	—	30	55		
Turn-on time $t_{on}$ ( $t_{on} = t_d(on) + t_r$ )	$t_d(on)$	—	30	45	ns	$V_{CC} = 30V$ $I_D = 1,9A$ $V_{GS} = 10V$ $R_{GS} = 50\Omega$
	$t_r$	—	40	60		
Turn-off time $t_{off}$ ( $t_{off} = t_d(off) + t_f$ )	$t_d(off)$	—	110	140	ns	
	$t_f$	—	60	80		

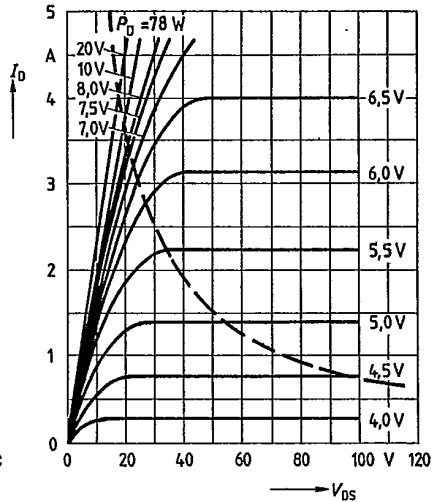
### Reverse diode

Continuous reverse drain current	$I_{DR}$	—	—	2,3	A	$T_C = 25^\circ\text{C}$
Pulsed reverse drain current	$I_{DRM}$	—	—	9,0		
Diode forward on-voltage	$V_{SD}$	—	1,05	1,3	V	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V, T_J = 25^\circ\text{C}$
Reverse recovery time	$t_{rr}$	—	2000	—	ns	$T_J = 25^\circ\text{C}$
Reverse recovery charge	$Q_{rr}$	—	15	—		$\mu C$

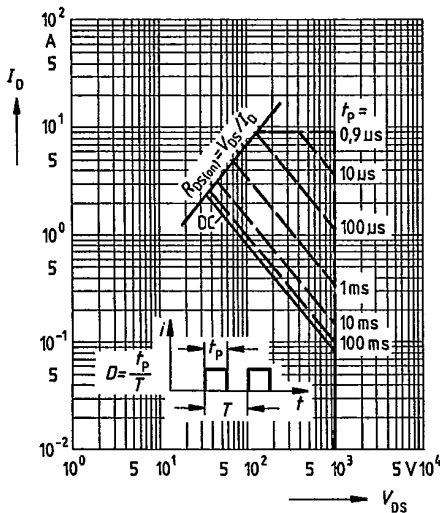
Power dissipation  $P_D = f(T_C)$



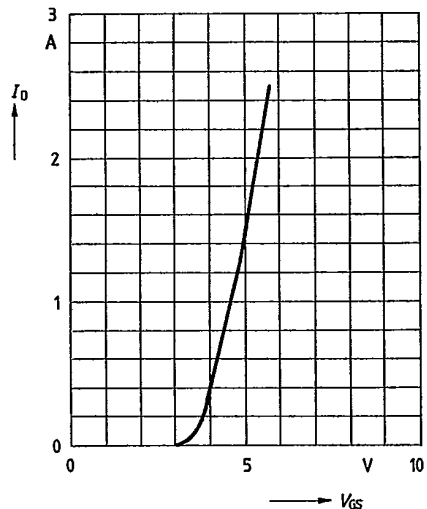
Typical output characteristics  $I_D = f(V_{DS})$   
parameter: 80  $\mu$ s pulse test,  
 $T_j = 25^\circ\text{C}$



Safe operating area  $I_D = f(V_{DS})$   
parameter:  $D = 0.01$ ,  $T_C = 25^\circ\text{C}$



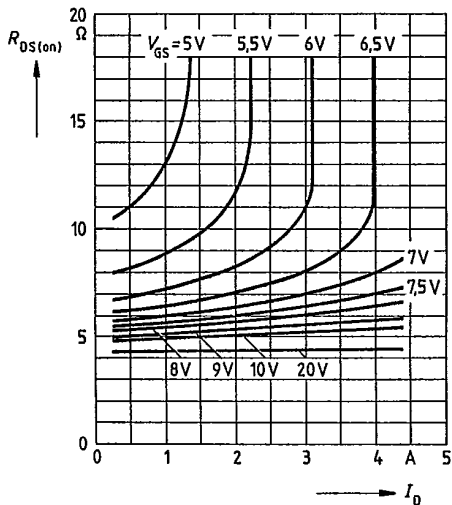
Typical transfer characteristic  $I_D = f(V_{GS})$   
parameter: 80  $\mu$ s pulse test,  
 $V_{DS} = 25\text{V}$ ,  $T_j = 25^\circ\text{C}$



**Typical drain-source on-state resistance**

$R_{DS(on)} = f(I_D)$

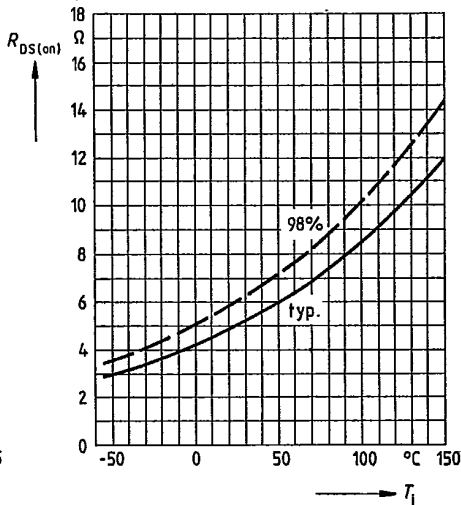
parameter:  $V_{GS}$ ;  $T_j = 25^\circ\text{C}$



**Drain-source on-state resistance**

$R_{DS(on)} = f(T_j)$

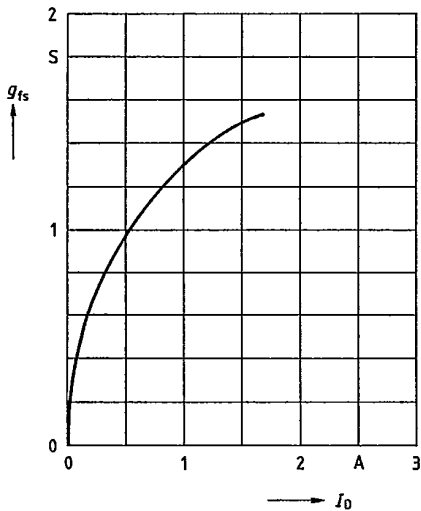
parameter:  $I_D = 1.5\text{A}$ ,  $V_{GS} = 10\text{V}$   
(spread)



**Typical transconductance  $g_{fs} = f(I_D)$**

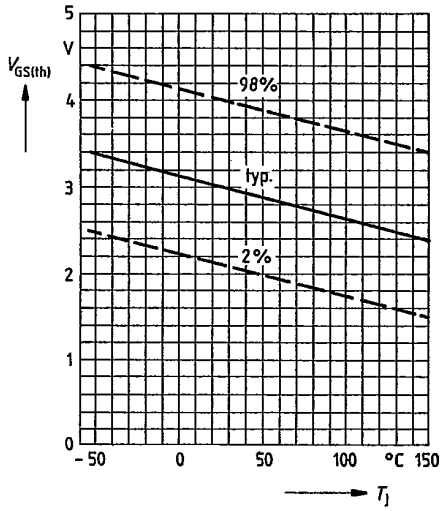
parameter: 80  $\mu\text{s}$  pulse test,

$V_{DS} = 25\text{V}$ ,  $T_j = 25^\circ\text{C}$

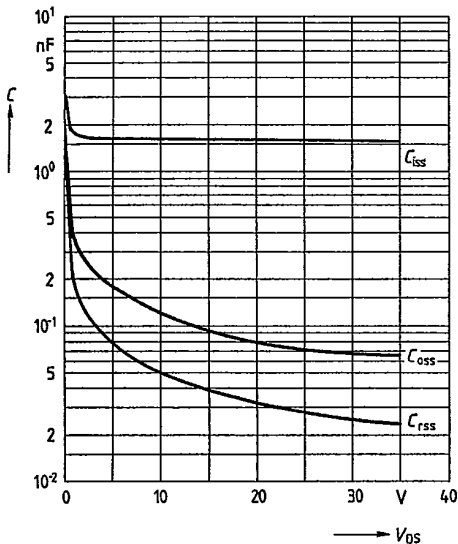


**Gate threshold voltage  $V_{GS(th)} = f(T_j)$**

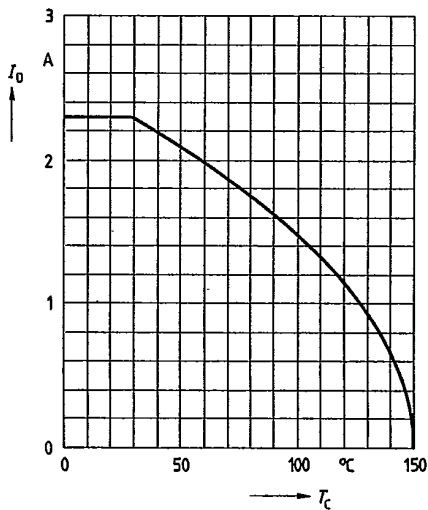
parameter:  $V_{DS} = V_{GS}$ ,  $I_D = 1\text{mA}$   
(spread)



**Typical capacitances  $C = f(V_{DS})$**   
 parameter:  $V_{GS} = 0$ ,  $f = 1\text{MHz}$

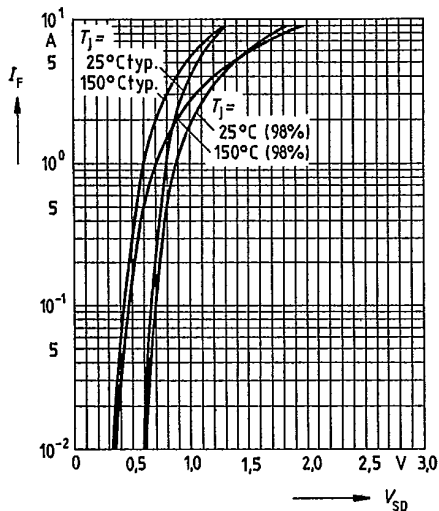


**Continuous drain current  $I_D = f(T_C)$**   
 parameter:  $V_{GS} \geq 10\text{V}$

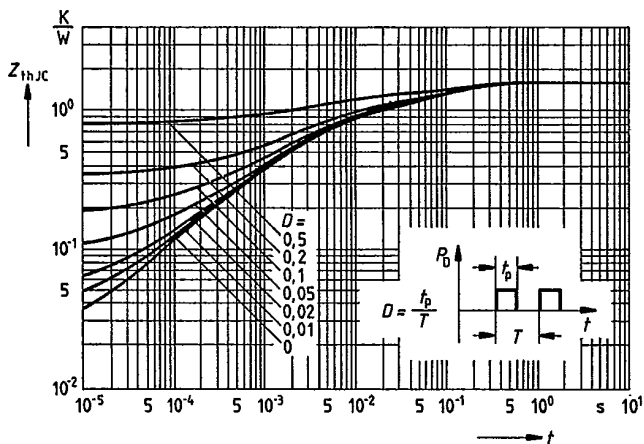


**Forward characteristic of reverse diode**

$I_F = f(V_{SD})$   
 parameter:  $T_J$ ,  $t_p = 80 \mu\text{s}$   
 (spread)



**Transient thermal impedance  $Z_{thJC} = f(t)$**   
 parameter:  $D = t_p/T$



**Typical gate-charge  $V_{GS} = f(Q_{Gate})$**   
 parameter:  $I_{D\ puls} = 3,75A$

